No. STSE-CM6126B
<Cat.No.070227>

SPECIFICATIONS FOR NICHIA CHIP TYPE **FULL COLOR** LED

MODEL : **NSSM016DT**

NICHIA CORPORATION

1.SPECIFICATIONS

(1) Absolute Maximum Ratings (Ta=25°C)

Item	Symbol	Absolute Maximum Rating			Unit
		Blue	Green	Red	
Forward Current	I_F	35	35	50	mA
Pulse Forward Current *	I_{FP}	110	110	200	mA
Reverse Voltage	V_R	5			V
Power Dissipation **	P_D	123	123	125	mW
Total Power Dissipation ***	P_{tot}	280			mW
Operating Temperature	T_{opr}	-30 ~ + 85			°C
Storage Temperature	T_{stg}	-40 ~ +100			°C
Soldering Temperature	T_{sld}	Reflow Soldering : 260°C for 10sec. Hand Soldering : 350°C for 3sec.			

* I_{FP} Conditions : Pulse Width ≦ 10msec. and Duty ≦ 1/10

** Value for one LED device (Single color).

*** Value for total power dissipation when two and more devices are lit simultaneously.

(2) Initial Electrical/Optical Characteristics (Ta=25°C)

Item		Symbol	Condition	Blue		Green		Red		Unit
				Typ.	Max.	Typ.	Max.	Typ.	Max.	
Forward Voltage		V_F	I_F=20[mA]	(3.2)	3.5	(3.2)	3.5	(2.1)	2.5	V
Reverse Current		I_R	V_R= 5[V]	-	50	-	50	-	50	μA
Luminous Intensity		Iv	I_F=20[mA]	(400)	-	(1600)	-	(700)	-	mcd
Chromaticity Coordinate *	x	-	I_F=20[mA]	0.133	-	0.189	-	0.700	-	-
	y	-	I_F=20[mA]	0.075	-	0.718	-	0.299	-	-

* Please refer to CIE 1931 chromaticity diagram.

(3) Ranking (Ta=25°C)

Item	Symbol	Condition	Blue		Green		Red		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	
Luminous Intensity	Iv	I_F=20[mA]	280	560	1100	2200	380	1080	mcd

* Luminous Intensity Measurement allowance is ± 10%.

Color Ranks (I_F=20mA, Ta=25°C)

Blue

	Rank W					
x	0.139	0.129	0.113	0.134	0.145	0.152
y	0.035	0.050	0.080	0.105	0.072	0.056

Green

	Rank G0c					
x	0.166	0.136	0.176	0.220	0.237	0.201
y	0.676	0.739	0.750	0.745	0.684	0.686

Red

	Rank R			
x	0.674	0.648	0.677	0.708
y	0.296	0.323	0.323	0.292

∗ Color Coordinates Measurement allowance is ± 0.01.

2.INITIAL OPTICAL/ELECTRICAL CHARACTERISTICS

Please refer to figure's page.

3.OUTLINE DIMENSIONS AND MATERIALS

Please refer to figure's page.

Material as follows ;	Package	:	Heat-Resistant Polymer
	Package Upper Surface Color	:	Black
	Encapsulating Resin	:	Epoxy Resin (Diffused)
	Electrodes	:	Ag Plating Copper Alloy

4.PACKAGING

· The LEDs are packed in cardboard boxes after taping.
Please refer to figure's page.
The label on the minimum packing unit shows ; Part Number, Lot Number, Quantity
· In order to protect the LEDs from mechanical shock, we pack them in cardboard boxes for transportation.
· The LEDs may be damaged if the boxes are dropped or receive a strong impact against them, so precautions must be taken to prevent any damage.
· The boxes are not water resistant and therefore must be kept away from water and moisture.
· When the LEDs are transported, we recommend that you use the same packing method as Nichia.

5.LOT NUMBER

The first six digits number shows **lot number**.
The lot number is composed of the following characters;

○□××××

○ - Year (6 for 2006, 7 for 2007)
□ - Month (1 for Jan., 9 for Sep., A for Oct., B for Nov.)
×××× - Nichia's Product Number

6.RELIABILITY

(1) TEST ITEMS AND RESULTS

Test Item	Standard Test Method	Test Conditions	Note	Number of Damaged
Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701 300 301	Tsld=260°C, 10sec. (Pre treatment 30°C,70%,168hrs.)	2 times	0/50
Thermal Shock	JEITA ED-4701 300 307	0°C ~ 100°C 15sec. 15sec.	100 cycles	0/50
Temperature Cycle	JEITA ED-4701 100 105	-40°C ~ 25°C ~ 100°C ~ 25°C 30min. 5min. 30min. 5min.	100 cycles	0/50
Moisture Resistance Cyclic	JEITA ED-4701 200 203	25°C ~ 65°C ~ -10°C 90%RH 24hrs./1cycle	10 cycles	0/50
High Temperature Storage	JEITA ED-4701 200 201	Ta=100°C	500hrs.	0/50
Temperature Humidity Storage	JEITA ED-4701 100 103	Ta=60°C, RH=90%	500hrs.	0/50
Low Temperature Storage	JEITA ED-4701 200 202	Ta=-40°C	500hrs.	0/50
Steady State Operating Life		∗ Ta=25°C, B I_F=15mA G I_F=35mA R I_F=25mA	500hrs.	0/50
Steady State Operating Life of High Humidity Heat		∗ 60°C, RH=90%, B I_F=10mA G I_F=15mA R I_F=15mA	500hrs.	0/50
Steady State Operating Life of Low Temperature		∗ Ta=-30°C, B I_F=15mA G I_F=35mA R I_F=25mA	500hrs.	0/50

∗ Value for one LED device (Single color).

(2) CRITERIA FOR JUDGING DAMAGE (Value for one LED device (Single color).)

Item	Symbol	Test Conditions	Criteria for Judgement	
			Min.	Max.
Forward Voltage	V_F	B,G,R I_F=20mA	-	U.S.L.*)×1.1
Reverse Current	I_R	B,G,R V_R=5V	-	U.S.L.*)×2.0
Luminous Intensity	I_V	B,G,R I_F=20mA	L.S.L.**)×0.7	-

*) U.S.L. : Upper Standard Level **) L.S.L. : Lower Standard Level

7.CAUTIONS

(1) Moisture Proof Package

· When moisture is absorbed into the SMT package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep moisture to a minimum in the package.

· The moisture proof package is made of an aluminum moisture proof bag. A package of a moisture absorbent material (silica gel) is inserted into the aluminum moisture proof bag. The silica gel changes its color from blue to pink as it absorbs moisture.

(2) Storage

· Storage Conditions

Before opening the package :

The LEDs should be kept at 30°C or less and 90%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.

After opening the package :

The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs should be soldered within 168 hours (7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.

· If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : more than 24 hours at 65 ± 5°C

· Nichia LED electrodes are silver plated copper alloy. The silver surface may be affected by environments which contain corrosive substances. Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the User use the LEDs as soon as possible.

· Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

(3) Heat Generation

· Thermal design of the end product is of paramount importance. Please consider the heat generation of the LED when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.

· During operation of the LEDs the total power dissipation of the diode elements (red, green, and blue) within the LEDs must not exceed the maximum power dissipation.

· The operating current should be decided after considering the ambient maximum temperature of LEDs.

(4) Soldering Conditions

· The LEDs can be soldered in place using the reflow soldering method. Nichia cannot make a guarantee on the LEDs after they have been assembled using the dip soldering method.

· Recommended soldering conditions

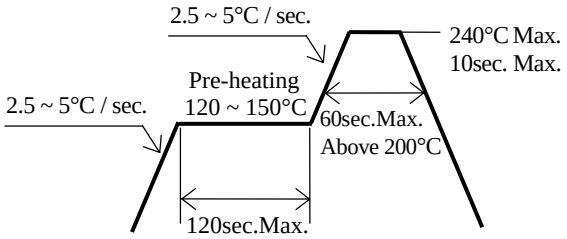
Reflow Soldering			Hand Soldering	
	Lead Solder	Lead-free Solder		
Pre-heat	120 ~ 150°C	180 ~ 200°C	Temperature	350°C Max.
Pre-heat time	120 sec. Max.	120 sec. Max.	Soldering time	3 sec. Max.
Peak temperature	240°C Max.	260°C Max.		(one time only)
Soldering time	10 sec. Max.	10 sec. Max.		
Condition	refer to Temperature - profile ①.	refer to Temperature - profile ②. (N_2 reflow is recommended.)		

∗ Although the recommended soldering conditions are specified in the above table, reflow or hand soldering at the lowest possible temperature is desirable for the LEDs.

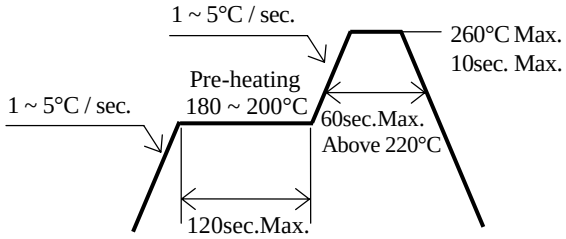
∗ A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

[Temperature-profile (Surface of circuit board)] Use the conditions shown to the under figure.

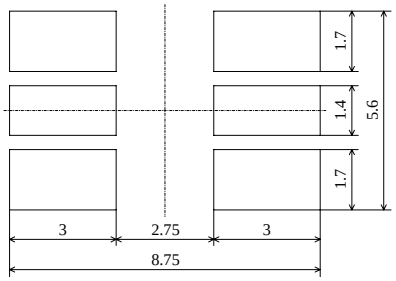
<① : Lead Solder>



<② : Lead-free Solder>



[Recommended soldering pad design] Use the following conditions shown in the figure.



(Unit : mm)

· Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.

· Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

· Reflow soldering should not be done more than two times.

· When soldering, do not put stress on the LEDs during heating.

· After soldering, do not warp the circuit board.

(5) Cleaning

· It is recommended that isopropyl alcohol be used as a solvent for cleaning the LEDs. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not. Freon solvents should not be used to clean the LEDs because of worldwide regulations.

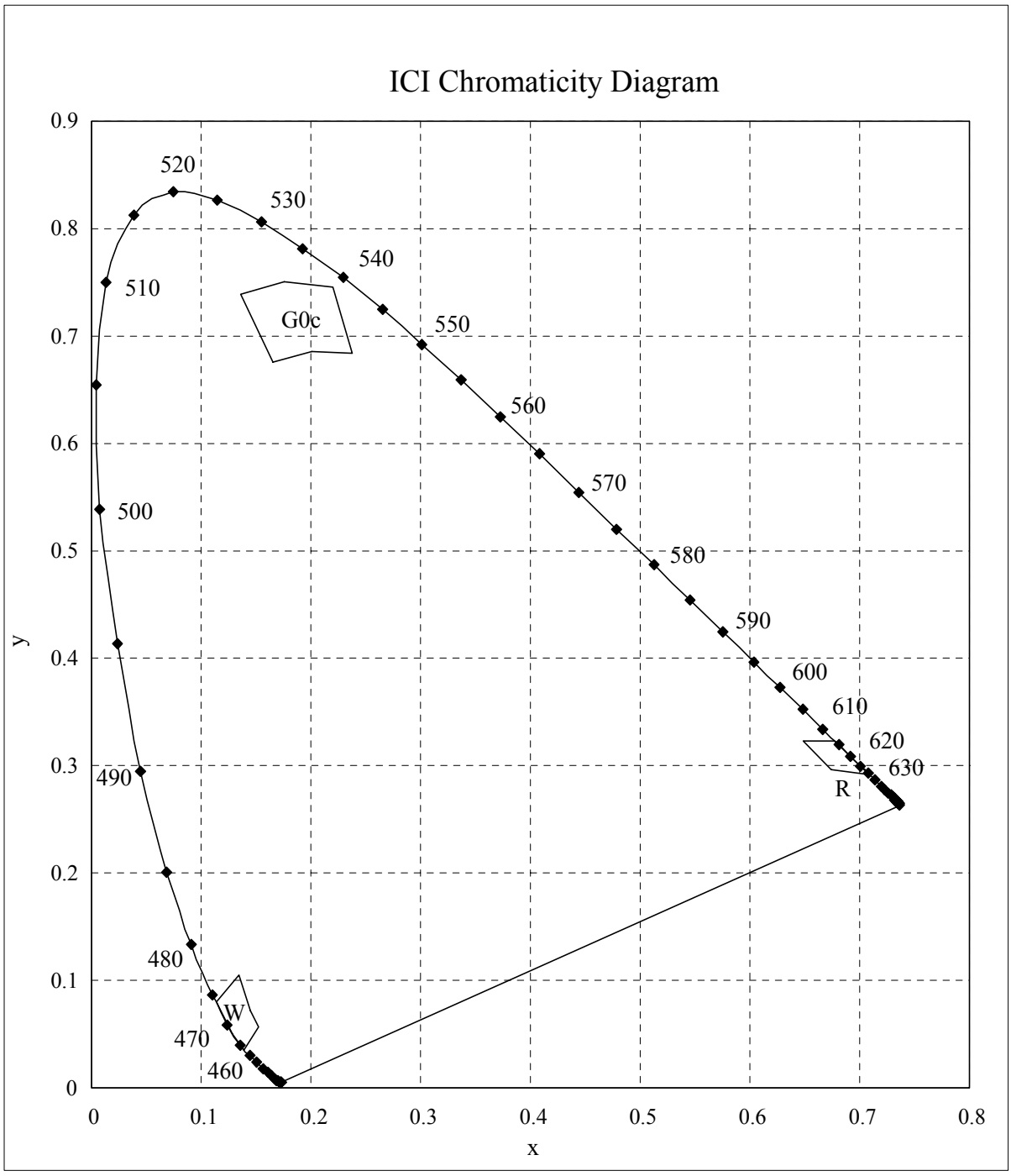
· Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

(6) Static Electricity

· Static electricity or surge voltage damages the Blue/Green LEDs.
It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.
· All devices, equipment and machinery must be properly grounded. It is recommended that precautions be taken against surge voltage to the equipment that mounts the LEDs.
· When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a VF test at a lower current (below 1mA is recommended).
· Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current.
Criteria : (V_F > 2.0V at I_F=0.5mA)

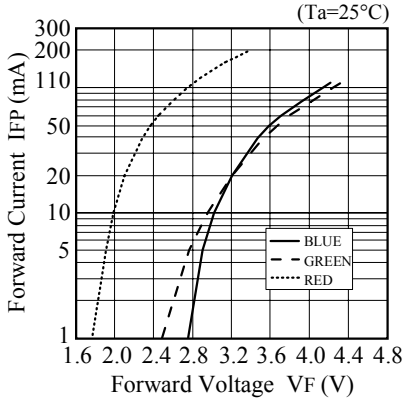
(7) Others

· NSSM016D complies with RoHS Directive.
· Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
· The LED light output is strong enough to injure human eyes. Precautions must be taken to prevent looking directly at the LEDs with unaided eyes for more than a few seconds.
· Flashing lights have been known to cause discomfort in people; you can prevent this by taking precautions during use. Also, people should be cautious when using equipment that has had LEDs incorporated into it.
· The LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult Nichia's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control systems, automobiles, traffic control equipment, life support systems and safety devices).
· User shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from Nichia. When defective LEDs are found, the User shall inform Nichia directly before disassembling or analysis.
· The formal specifications must be exchanged and signed by both parties before large volume purchase begins.
· The appearance and specifications of the product may be modified for improvement without notice.

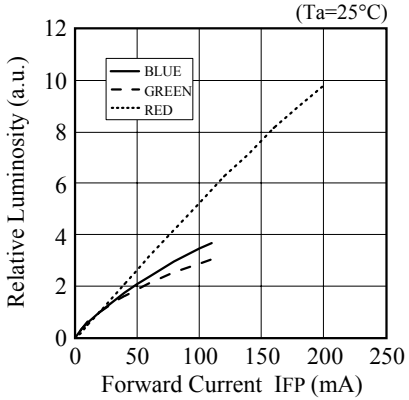


＊ Color Coordinates Measurement allowance is ± 0.01.

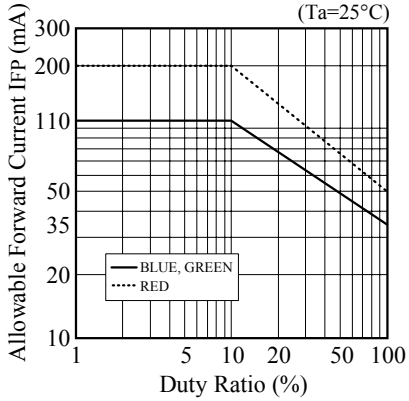
■ Forward Voltage vs. Forward Current



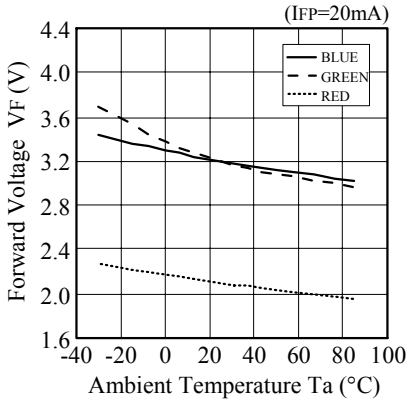
■ Forward Current vs. Relative Luminosity



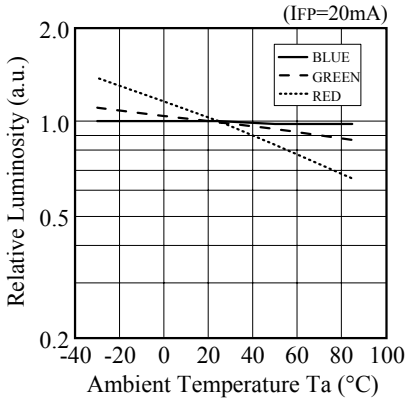
■ Duty Ratio vs. Allowable Forward Current



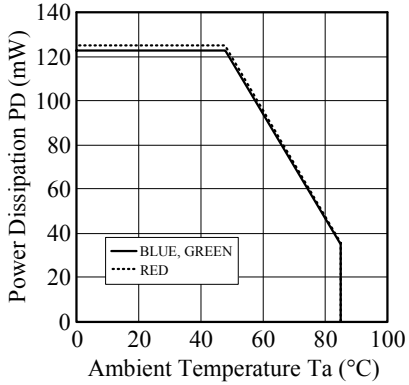
■ Ambient Temperature vs. Forward Voltage



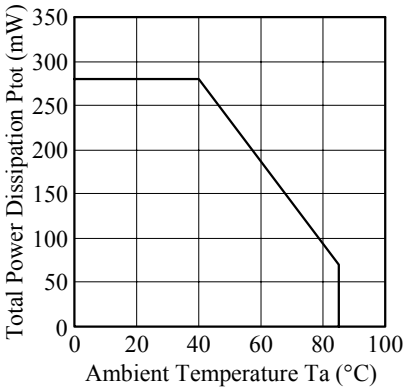
■ Ambient Temperature vs. Relative Luminosity



■ Ambient Temperature vs. Power Dissipation ＊



■ Ambient Temperature vs. Power Dissipation ＊＊



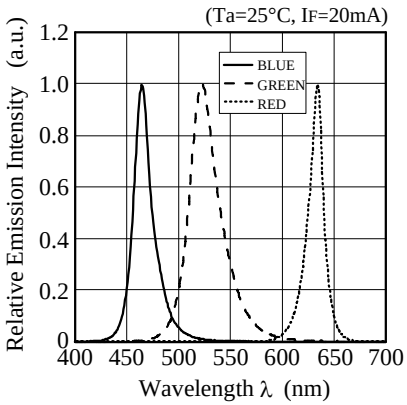
(NOTE) ＊ The value for one device should be within the absolute maximum rating when one or two and more devices are lit (Full color).

＊＊ Total value should be within the absolute maximum rating when two and more devices are lit (Full color).

NICHIA CORPORATION	Model NSSM016D	
	Title CHARACTERISTICS	
	No. 070221658212	

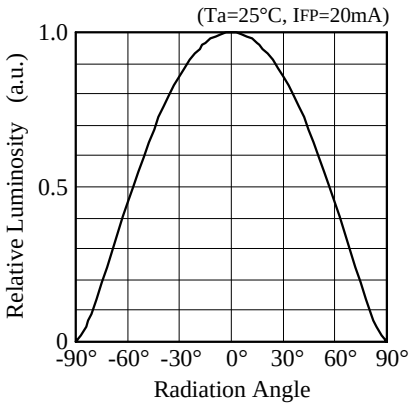
Nichia STSE-CM6126B
<Cat.No.070227>

■ Spectrum

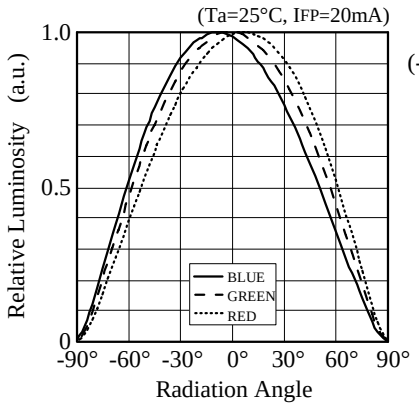


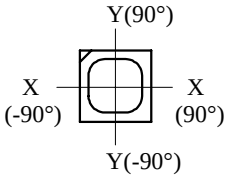
■ Directivity

X-X



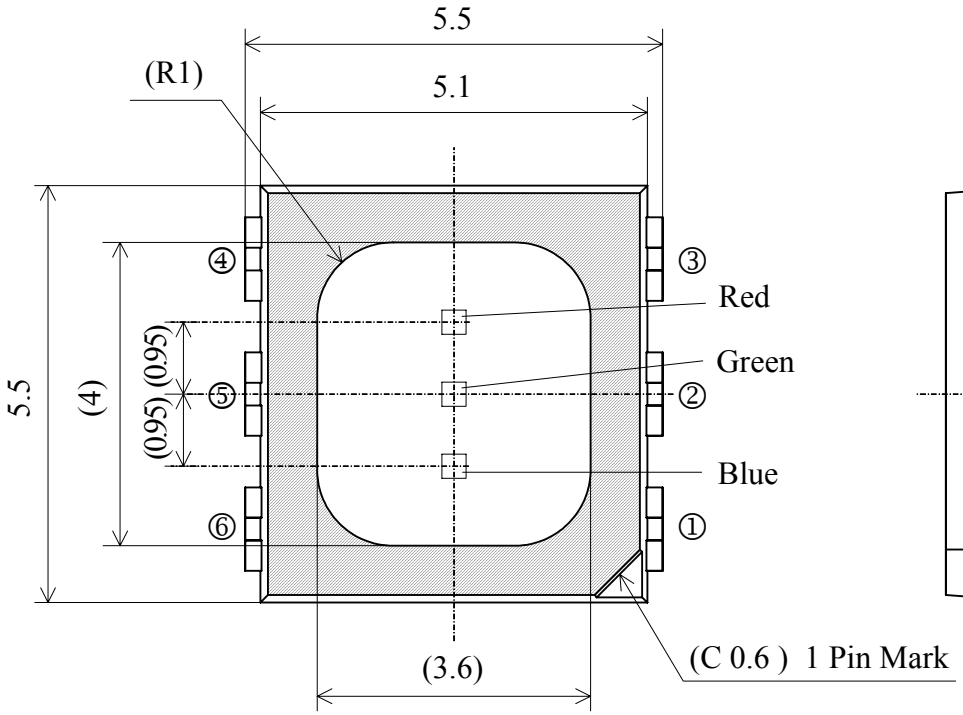
Y-Y

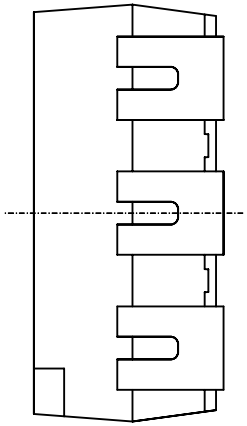


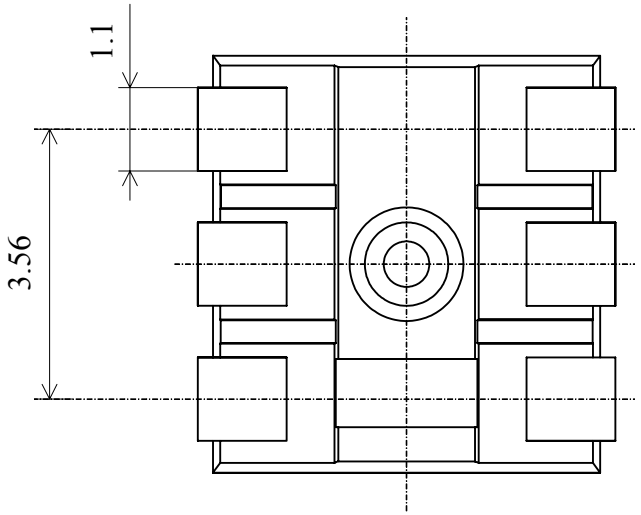


NICHIA CORPORATION	Model	NSSM016D
	Title	CHARACTERISTICS
	No.	070316658222

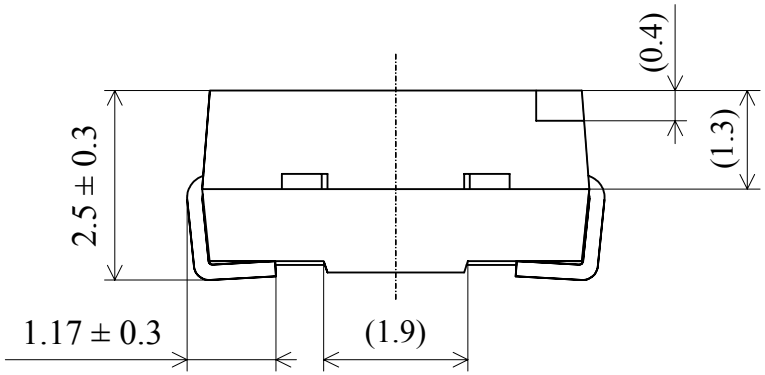
Nichia STSE-CM6126B-1
<Cat.No.070323>

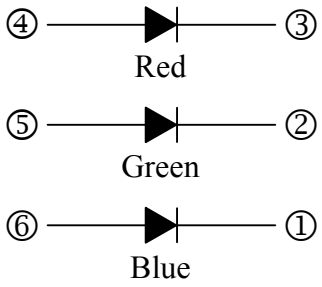






: Black



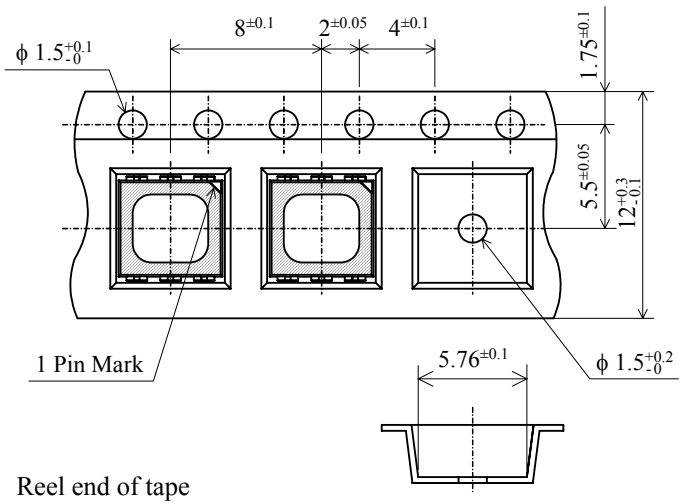


ITEM	MATERIALS
PACKAGE	Heat-Resistant Polymer
PACKAGE UPPER SURFACE COLOR	Black
ENCAPSULATING RESIN	Epoxy Resin (Diffused)
ELECTRODES	Ag Plating Copper Alloy

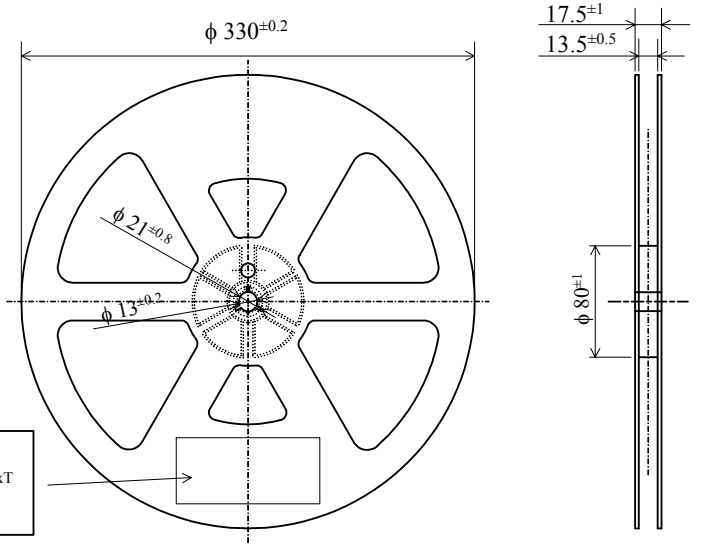
∗ Red LED die and blue LED die are mounted on the cathode side, green LED die is mounted on the anode side.

NICHIA CORPORATION	Model NSSM016D	Unit mm
	Title OUTLINE DIMENSIONS	10/1 Scale
	No. 061121658231	Allow ±0.2

Taping part



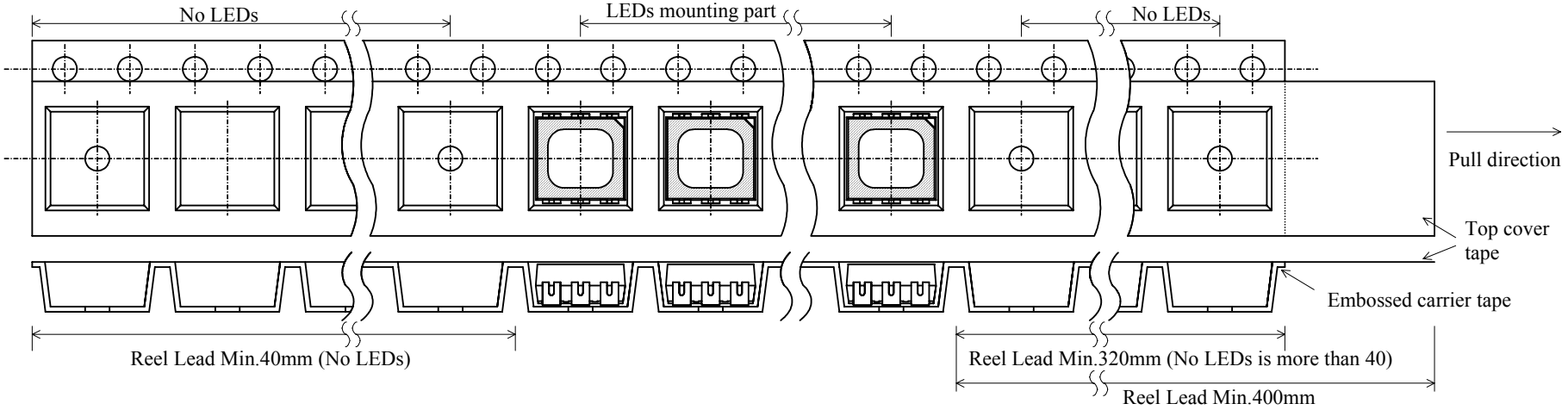
Reel part



Label

3in1 LED	
TYPE	NSSM016xT
LOT	XXXXXX
QTY	pcs

Reel end of tape

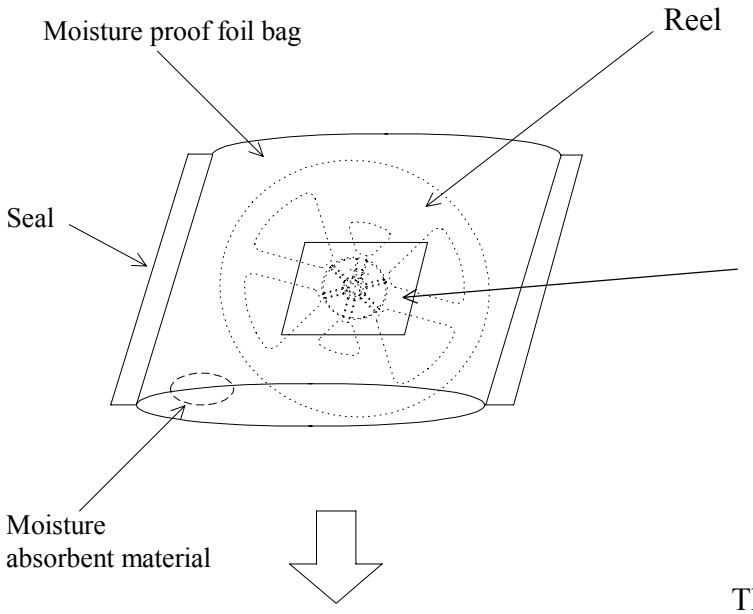


3,000pcs/Reel

Taping is based on the **JIS C 0806** : Packaging of Electronic Components on Continuous Tapes.

NICHIA CORPORATION	Model	NSSM016xT	Unit mm
	Title	TAPING DIMENSIONS	Scale
	No.	050413425742	Allow

The reel and moisture absorbent material are put in the moisture proof foil bag and then heat sealed.



Label

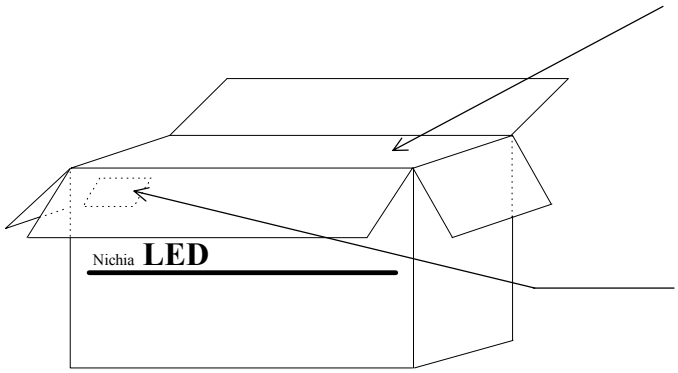
NICHIA

3in1 LED

TYPE NSSM016xT
LOT xxxxxx
QTY PCS

NICHIA CORPORATION
491 OKA, KAMINAKA, ANAN, TOKUSHIMA, JAPAN

The box is partitioned with the cardboard.



Label

NICHIA

3in1 LED

TYPE NSSM016xT

QTY PCS

NICHIA CORPORATION
491 OKA, KAMINAKA, ANAN, TOKUSHIMA, JAPAN

Packing unit

	Reel/bag	Quantity/bag (pcs)
Moisture proof foil bag	1reel	3,000 MAX.

Cardboard box	Dimensions (mm)	Reel/box	Quantity/box (pcs)
Cardboard box S	391×379×149×8t	5reel MAX.	15,000 MAX.

NICHIA CORPORATION	Model	NSSM016xT
	Title	PACKING
	No.	050524540301